

Supporting Information

A facile strategy for fabricating self-healable, adhesive and highly sensitive flexible ionogel-based sensors

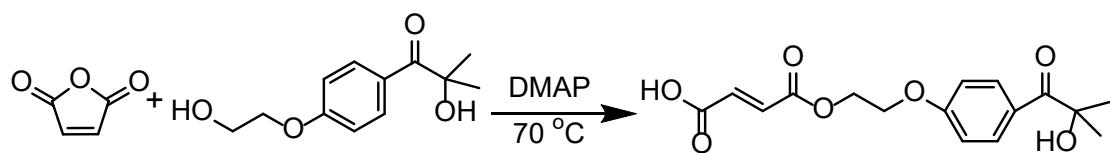
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Preparation of MAH-2959. The synthetic route of the polymerizable photoinitiators MAH-2959 is shown in Scheme S1. Irgacure 2959 (5.0 g, 22.3 mmol), MAH (2.3 g, 23.5 mmol) and 4-dimethylaminopyridine (DMAP, 0.01 g) as catalyst were dissolved in anhydrous tetrahydrofuran (20 mL), and the reaction system was then stirred at 70 °C for 8 h in the dark. The orange viscous product MAH-2959 was obtained after the removal of THF by rotary evaporation.



Scheme S1. The synthetic route of MAH-2959.

Characterization of MAH-2959. As shown in Fig. S1(a), the FTIR spectrum of MAH-2959 exhibited a typical C=O stretching vibration of ester groups at 1730 cm⁻¹. The proton nuclear magnetic resonance (¹H NMR) spectrum in Fig. S1(b) further demonstrated the successful formation of polymerizable photoinitiator MAH-2959.

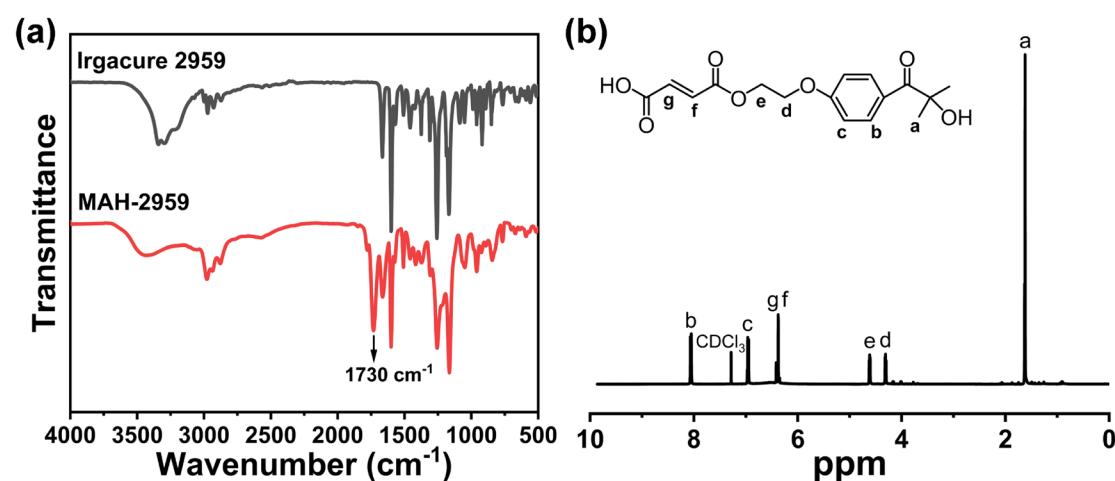


Fig. S1 (a) FTIR spectra of Irgacure 2959 and MAH-2959, (b) ¹H NMR spectrum of MAH-2959.

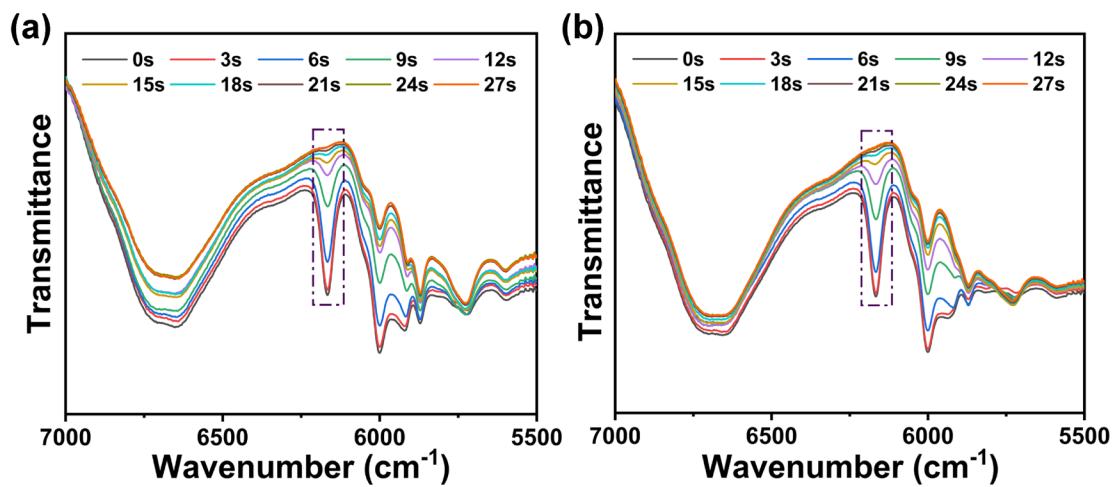


Fig. S2 FTIR spectra of PEI/PAA/DES ionogel prepared using (a) Irgacure 2959, (b) MAH-2959 in different reaction time.

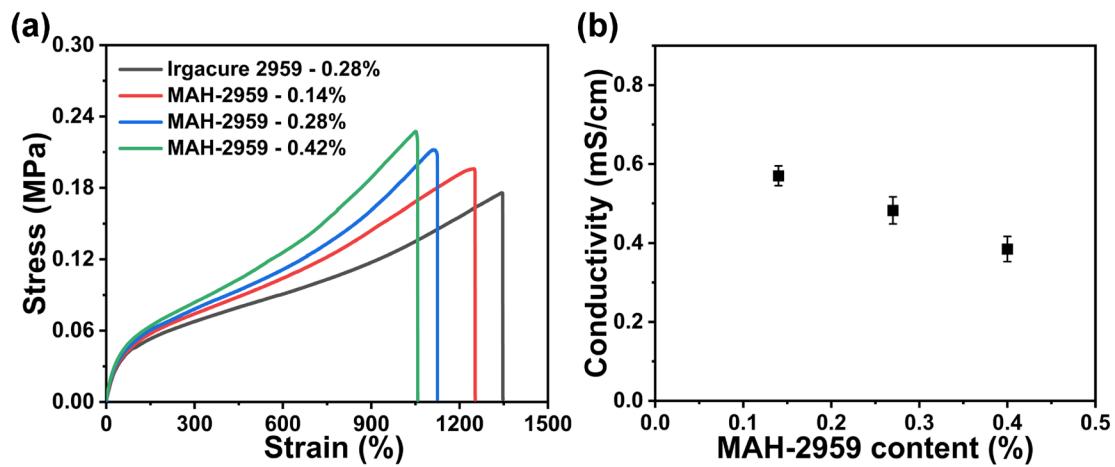


Fig. S3 (a) Tensile stress-strain curves and (b) conductivities of $\text{PEI}_{3.9}/\text{PAA}_9/\text{DES}_{72}$ ionogels prepared using different kind and content of photoinitiators.

Table S1. Compositions of PEI_x/PAA_y/DES_z ionogels (0.28 wt%MAH-2959 relative to AA monomer, CCl-U:10.38g).

Sample	AA(g)	Mass fraction of AA in ionogel (wt%)	PEI(g)	Mass fraction of PEI in ionogel (wt%)	Mass ratio of PEI/DES ($\times 10^2$)	Mass ratio of PAA/PEI	Mass fraction of DES in ionogel (wt%)
PEI _{3.2} /PAA ₁₁ /DES ₇₂	3.69	26	0.336	2.3	3.2	11	72
PEI _{3.9} /PAA ₉ /DES ₇₂	3.63	25	0.403	2.8	3.9	9	72
PEI _{4.9} /PAA ₇ /DES ₇₂	3.53	25	0.504	3.5	4.9	7	72
PEI _{5.6} /PAA ₆ /DES ₇₂	3.45	24	0.576	4.0	5.6	6	72
PEI _{4.7} /PAA ₉ /DES ₆₈	4.39	29	0.488	3.2	4.7	9	68
PEI _{3.3} /PAA ₉ /DES ₇₅	3.11	23	0.345	2.5	3.3	9	75
PEI _{2.8} /PAA ₉ /DES ₇₈	2.63	20	0.292	2.2	2.8	9	78
PEI _{3.2} /PAA ₁₁ /DES _{72.4}	3.63	25	0.330	2.3	3.2	11	72.4
PEI _{5.0} /PAA ₇ /DES _{71.4}	3.63	25	0.518	3.6	5.0	7	71.4
PEI _{7.0} /PAA ₅ /DES _{70.4}	3.63	25	0.725	4.9	7.0	5	70.4
PEI _{3.9} /PAA ₁₁ /DES _{68.2}	4.43	29	0.403	2.6	3.9	11	68.2
PEI _{3.9} /PAA ₇ /DES _{76.3}	2.82	21	0.403	3.0	3.9	7	76.3
PEI _{3.9} /PAA ₅ /DES _{81.1}	2.02	16	0.403	3.1	3.9	5	81.1

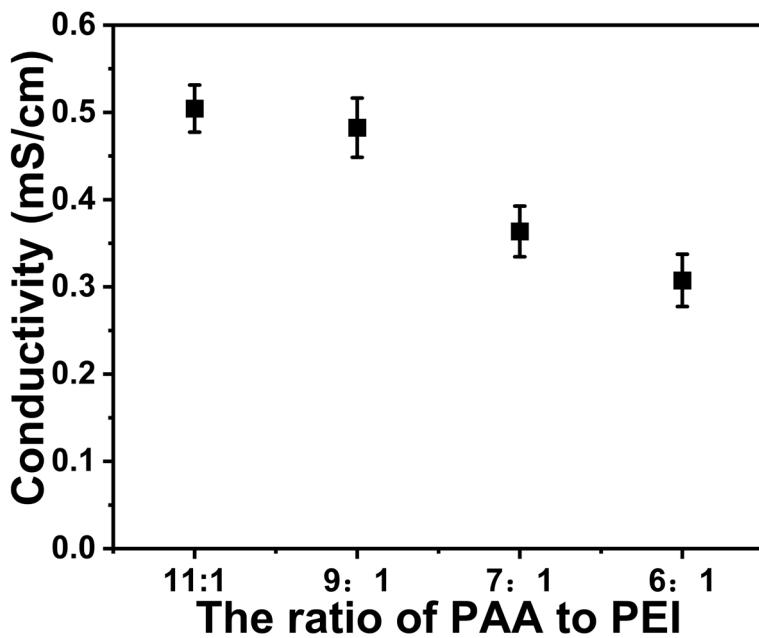


Fig. S4 Conductivities of $\text{PEI}_{3.2}/\text{PAA}_{11}/\text{DES}_{72}$, $\text{PEI}_{3.9}/\text{PAA}_9/\text{DES}_{72}$, $\text{PEI}_{4.9}/\text{PAA}_7/\text{DES}_{72}$

and $\text{PEI}_{5.6}/\text{PAA}_6/\text{DES}_{72}$.

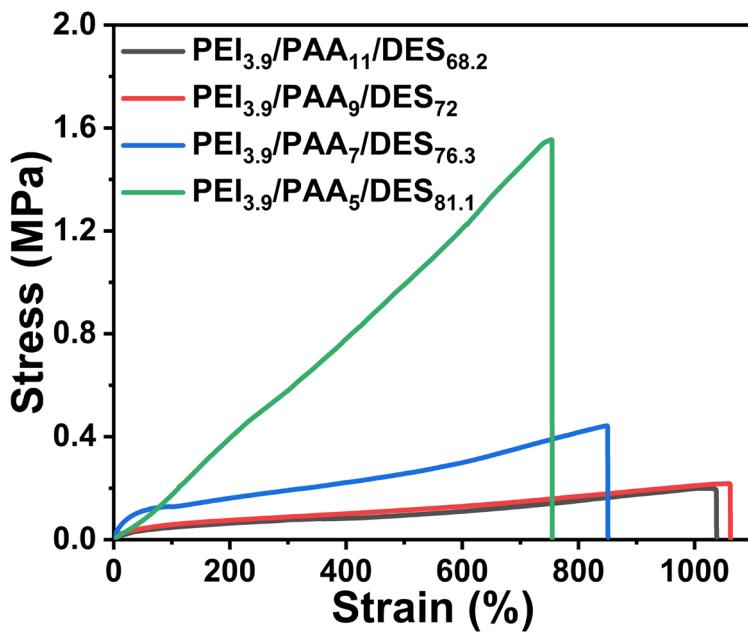


Fig. S5 Tensile stress-strain curves of $\text{PEI}_{3.9}/\text{PAA}_{11}/\text{DES}_{68.2}$, $\text{PEI}_{3.9}/\text{PAA}_9/\text{DES}_{72}$, $\text{PEI}_{3.9}/\text{PAA}_7/\text{DES}_{76.3}$ and $\text{PEI}_{3.9}/\text{PAA}_5/\text{DES}_{81.1}$.

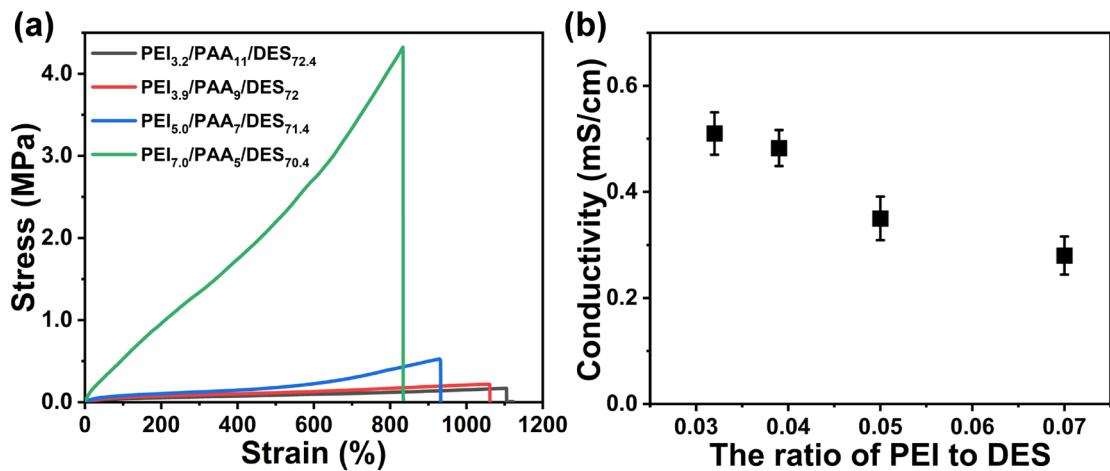


Fig. S6 (a) Tensile stress-strain curves and (b) conductivities of PEI_{3.2}/PAA₁₁/DES_{72.4}, PEI_{3.9}/PAA₉/DES₇₂, PEI_{5.0}/PAA₇/DES_{71.4} and PEI_{7.0}/PAA₅/DES_{70.4}.

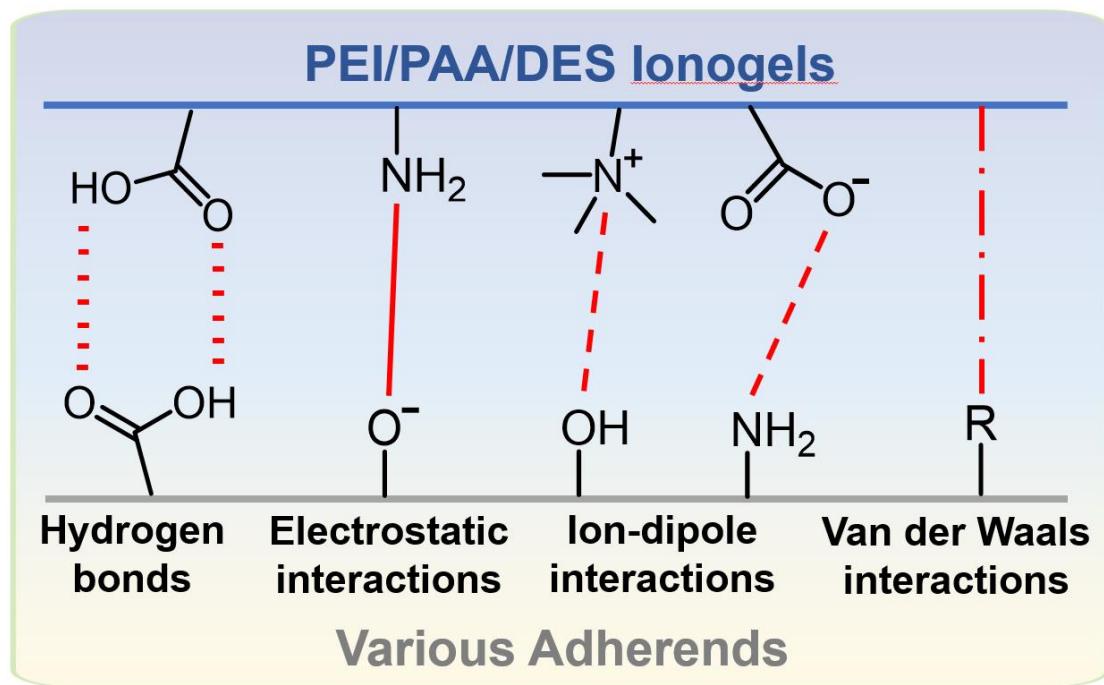


Fig. S7 The possible adhesive mechanisms between PEI/PAA/DES ionogels and various adherends.

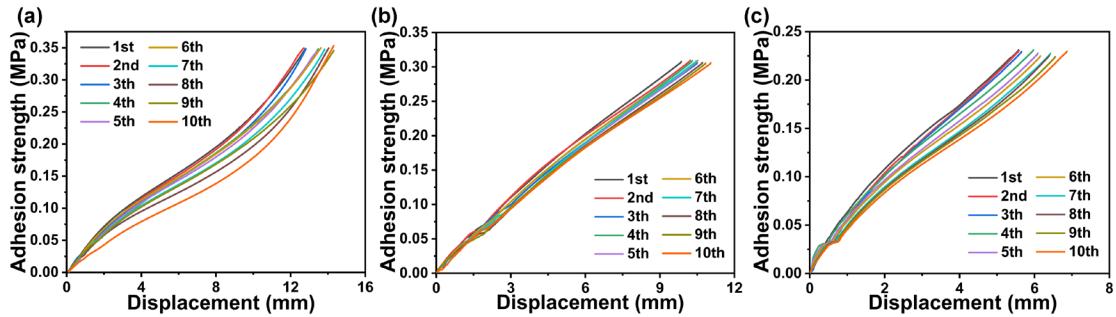


Fig. S8 The curves of adhesion strength vs displacement for $\text{PEI}_{3.9}/\text{PAA}_9/\text{DES}_{72}$ to (a) wood, (b) glass and (c) PVC during repeated adhesion progress.

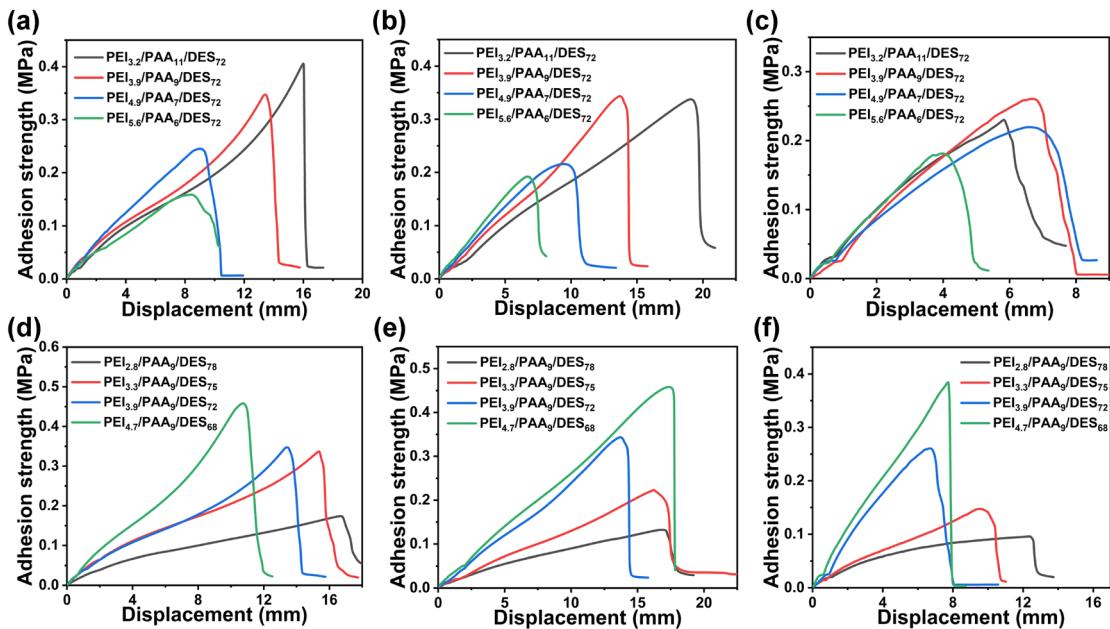


Fig. S9 Representative curves of adhesion strength vs displacement for $\text{PEI}_x/\text{PAA}_y/\text{DES}_{72}$ to (a) wood, (b) glass and (c) PVC with different ratio of PAA/PEI, Representative curves of adhesion strength vs displacement for $\text{PEI}_x/\text{PAA}_9/\text{DES}_z$ to (d) wood, (e) glass and (f) PVC with different polymer content.

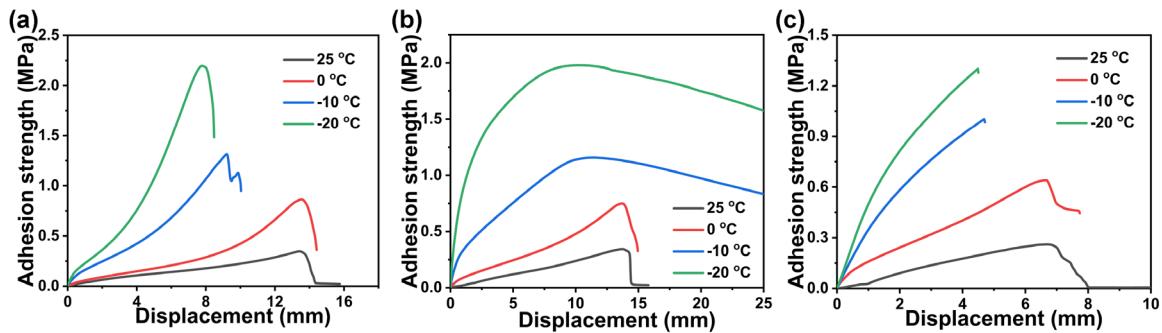


Fig. S10 Representative curves of adhesion strength vs displacement for PEI_{3.9}/PAA₉/DES₇₂ to (a) wood, (b) glass and (c) PVC at different temperature.

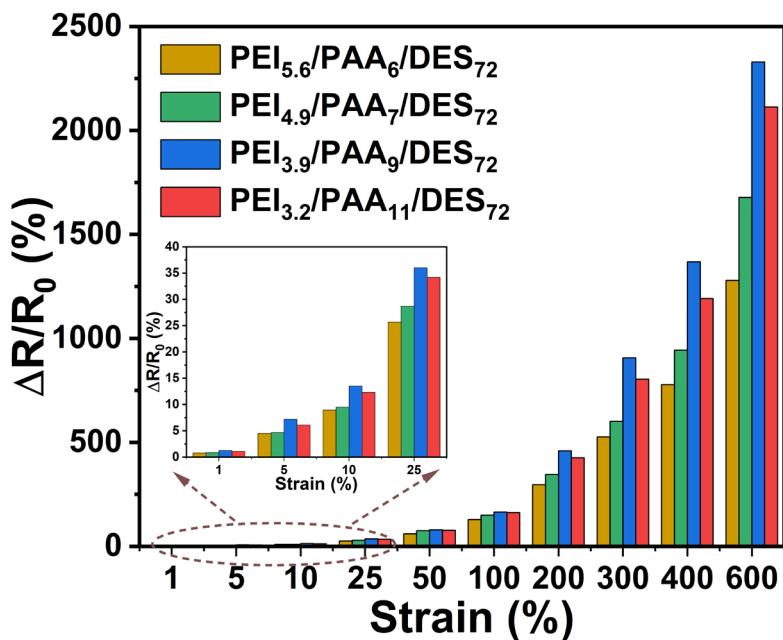


Fig. S11 Relative resistance changes of PEIx/PAAy/DES₇₂ ionogels with different ratio of PAA/PEI as a function of tensile strain.

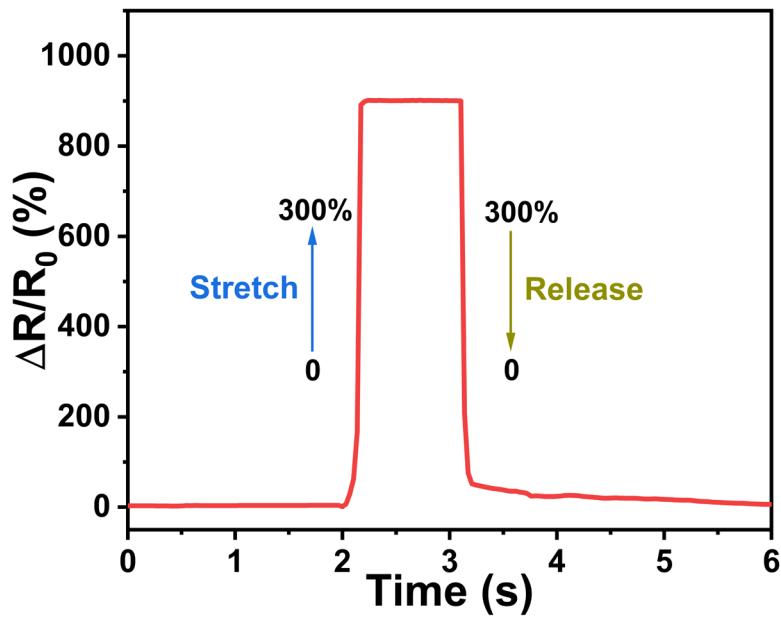


Fig. S12 Resistance changes of the PEI_{3.9}/PAA₉/DES₇₂ ionogel in the instantaneous loading-unloading process.

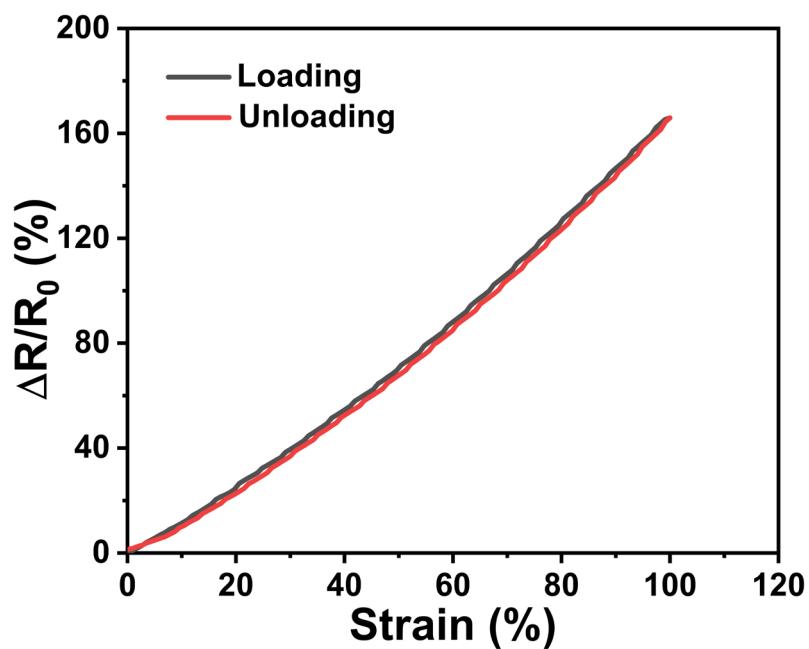


Fig. S13 Hysteresis curve of the PEI_{3.9}/PAA₉/DES₇₂ ionogel strain sensor at 100% strain.

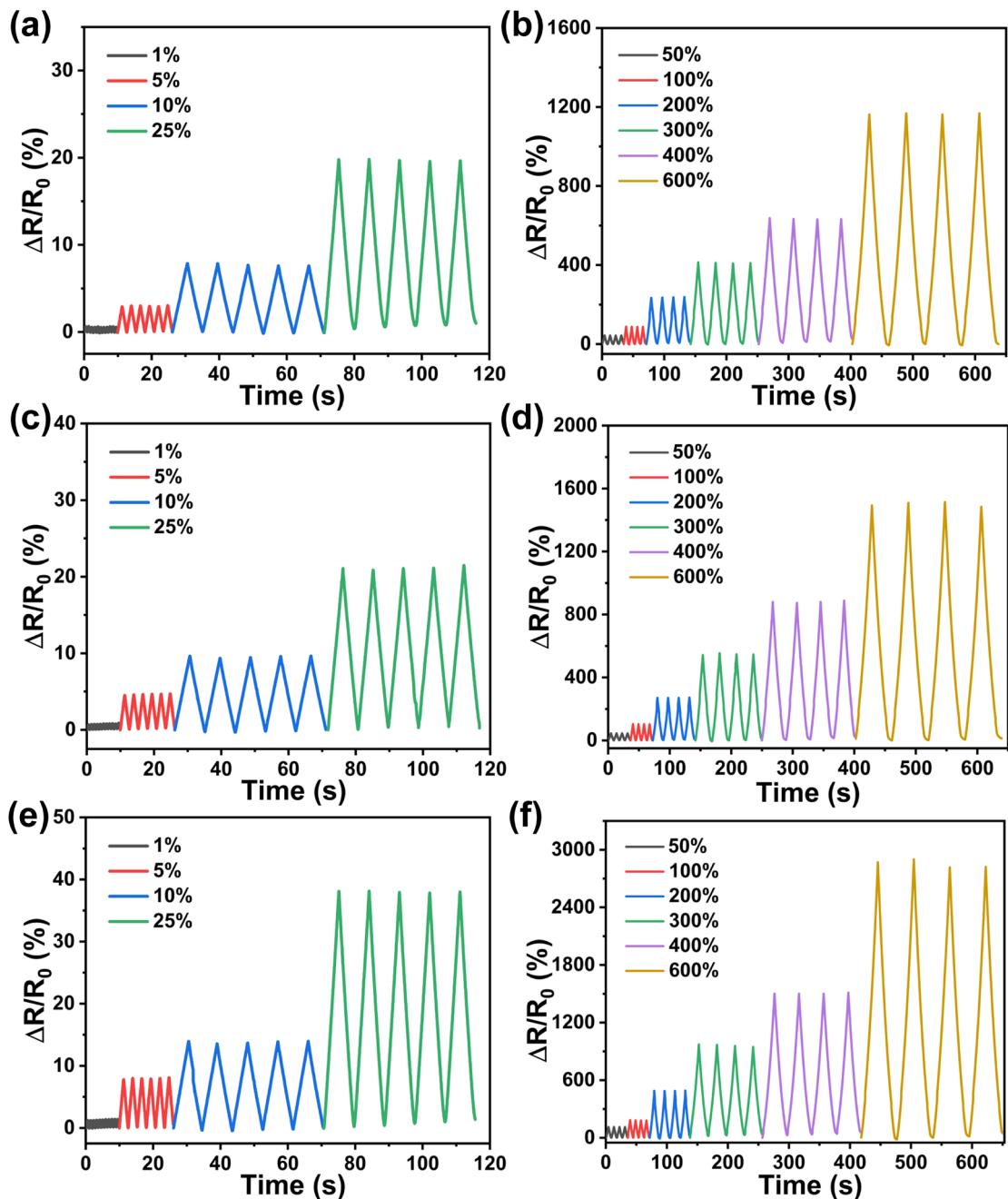


Fig. S14 Real-time monitoring of the relative resistance changes of (a-b) PEI_{2.8}/PAA₉/DES₇₈ ionogel, (c-d) PEI_{3.3}/PAA₉/DES₇₅ ionogel, and (e-f) PEI_{4.7}/PAA₉/DES₆₈ ionogel under different strains ranging from 1% to 600%.

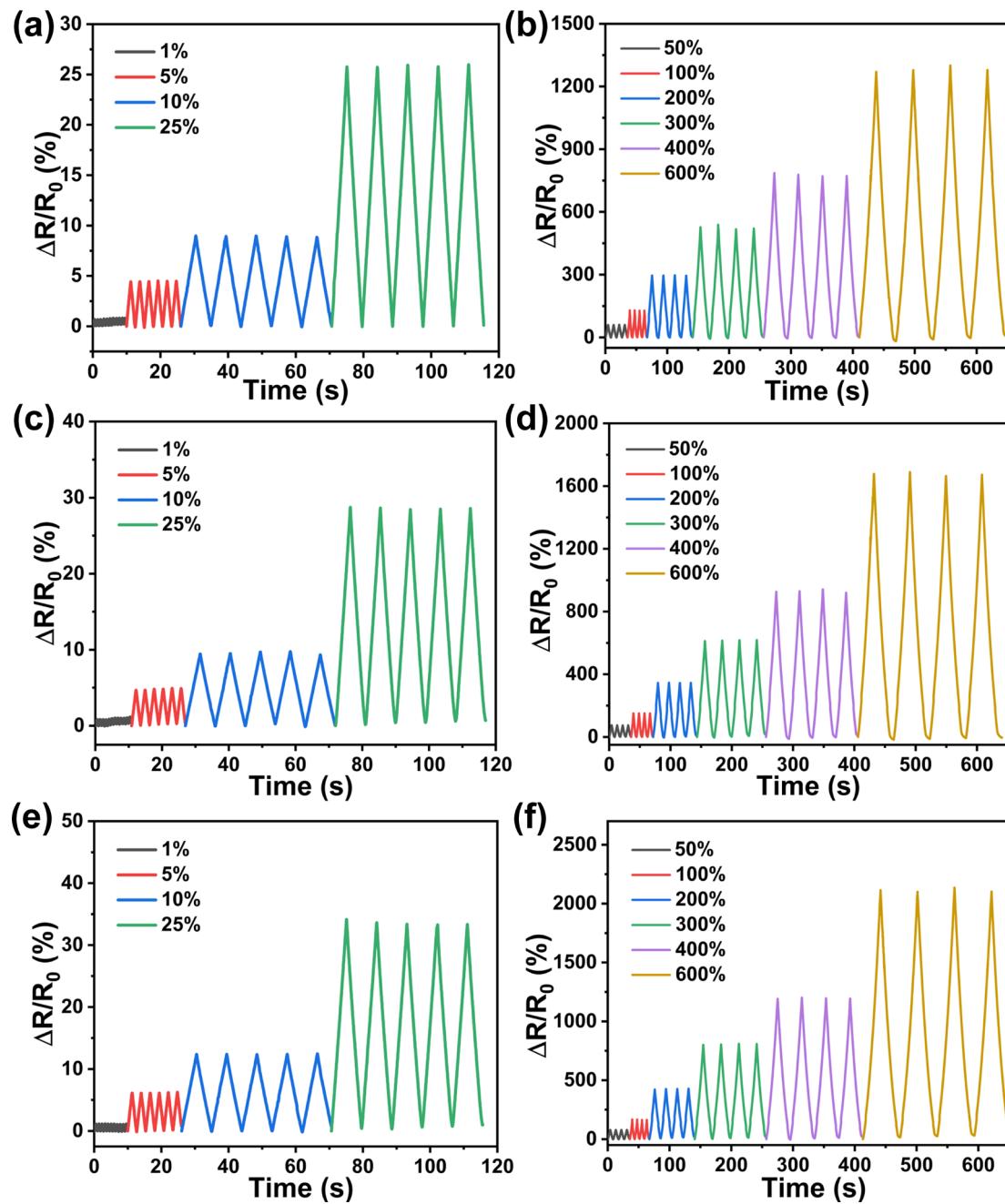


Fig. S15 Real-time monitoring of the relative resistance changes of (a-b) $\text{PEI}_{5.6}/\text{PAA}_6/\text{DES}_{72}$ ionogel, (c-d) $\text{PEI}_{4.9}/\text{PAA}_7/\text{DES}_{72}$ ionogel, and (e-f) $\text{PEI}_{3.2}/\text{PAA}_{11}/\text{DES}_{72}$ ionogel under different strains ranging from 1% to 600%.

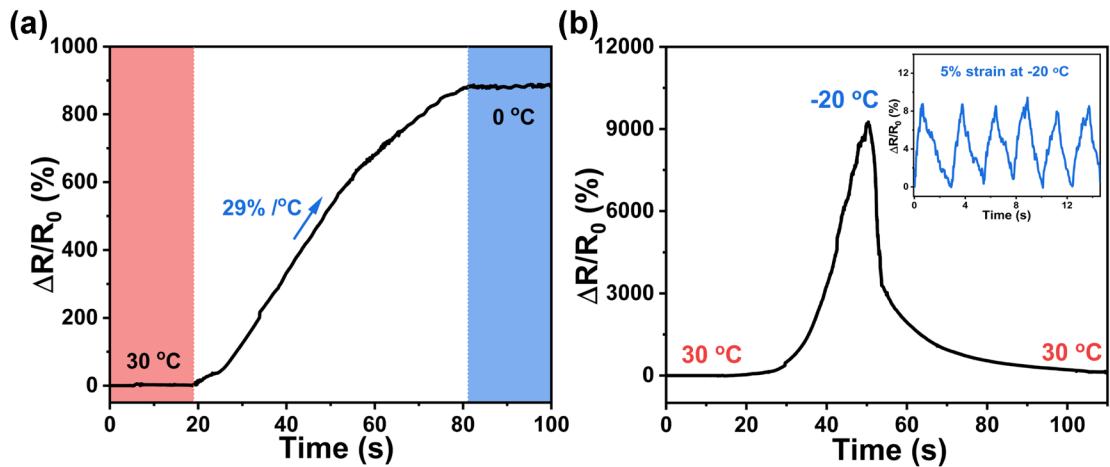


Fig. S16 (a) Resistance changes of the PEI_{3.9}/PAA₉/DES₇₂ ionogel for temperature detection (from 30 to 0 °C). (b) Resistance changes of the PEI_{3.9}/PAA₉/DES₇₂ ionogel during the cooling and heating process (between 30 and -20 °C). The inset displayed the real-time relative resistance changes of PEI_{3.9}/PAA₉/DES₇₂ under 5% strain at -20 °C.

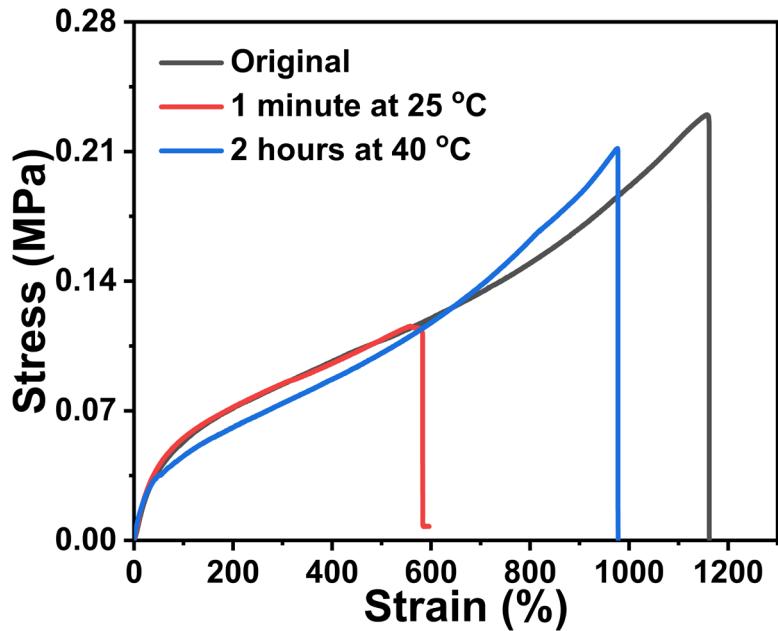


Fig. S17 Representative stress-strain curves of original and healed ionogel samples at different healing times and temperature.

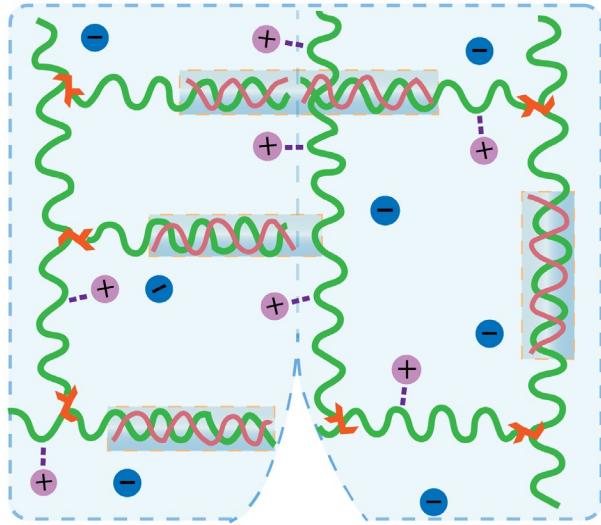


Fig. S18 The probable self-healing mechanism of the PEI/PAA/DES ionogels.

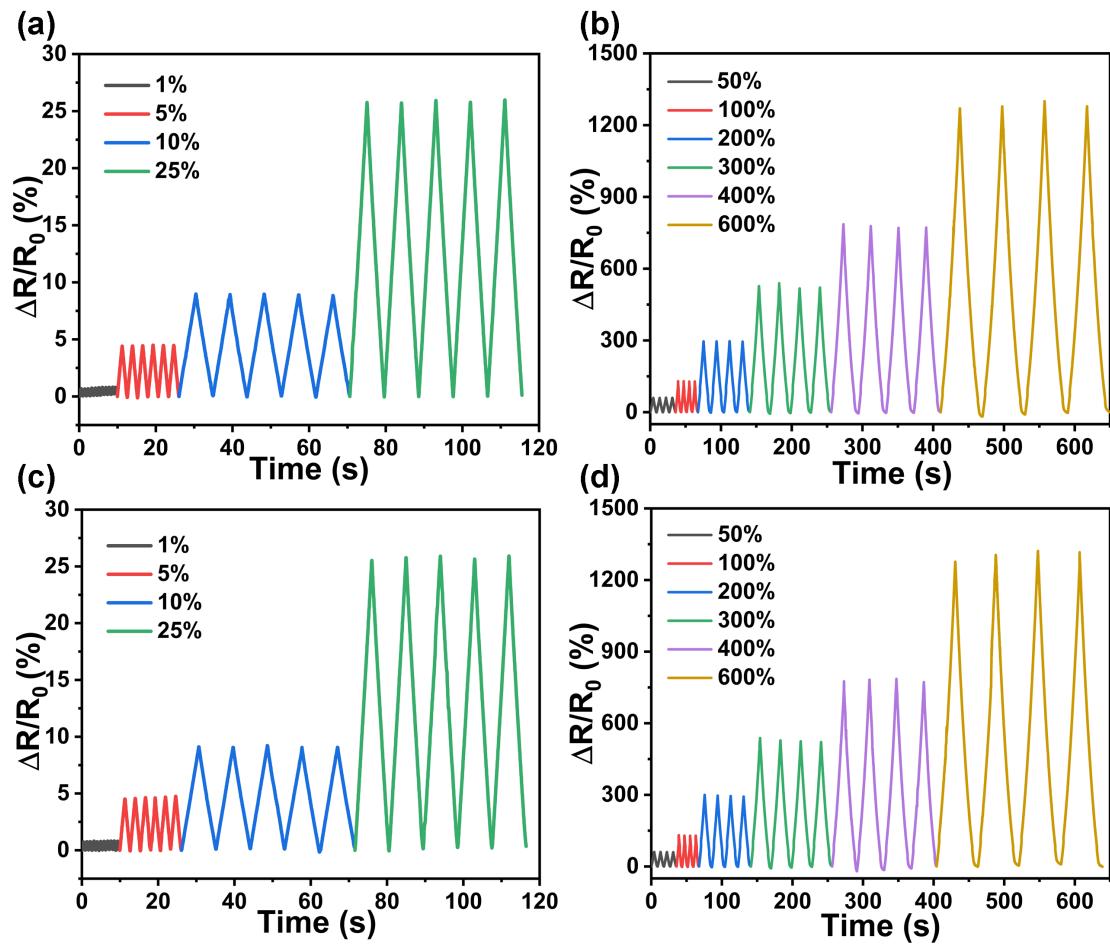


Fig. S19 Real-time monitoring of relative resistance of (a-b) $\text{PEI}_{5.6}/\text{PAA}_6/\text{DES}_{72}$ and (c-d) healed $\text{PEI}_{5.6}/\text{PAA}_6/\text{DES}_{72}$ under different strains ranging from 1% to 600%.

Table S2. A brief comparison of overall performance between PEI_{3.9}/PAA₉/DES₇₂-based strain sensor and representative ionogel-based sensors reported previously.

Ionogel-based sensor	GF	Maximum sensing range	Adhesive property (To glass)	Self-healing ability	Transmittance	Ref.
PEI/PAA/DES	4.68	600%	350 KPa	Yes	90%	This work
PVA/PVP/[EMIIm][DCA]	1.85	400%	NA	Yes	85%	1
MMA/[VMIIm][NTF ₂]	2.3	300%	280 KPa	NA	NA	2
P(TFEA-co-AAm)/ [EMIM][TFSI]	1.85	600%	1000 N/m	Yes	92%	3
Chitosan/dextran-TA	0.44	400%	19.7 KPa	Yes	NA	4
PU/[DEIM][TFSI]	1.54	300%	NA	Yes	NA	5
PAA/[EMIM]Cl	1.6	200%	32 KPa	NA	90%	6
PU/[PMIM][EFSI]	2.14	200%	NA	Yes	95%	7
P(VDF-co-HFP)/ P(MMA-co-BMA)/[EMIM][TFSI]	1.62	150%	NA	NA	93%	8
P(ACMO/UA)/[EMIM][TFSI]	1.56	300%	NA	Yes	NA	9
PEA/[C ₂ mim][NTf ₂]	1.83	200%	NA	NA	95%	10
PUU/ [EMIIm][DCA]	4.64	300%	Yes	Yes	93%	11

^{a)}NA: not applicable

References

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